

# CC1110/ CC2430/ CC2510 Debug and Programming Interface Specification

## *Rev. 1.2*



SWRA124

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#### 1 Introduction

The debug interface implements a proprietary two-wire serial interface that is used for in-circuit debugging. Through this debug interface it is possible to perform an erasure of the entire flash memory, control which oscillators are enabled, stop and start execution of the user program, execute supplied instructions on the 8051 core, set code breakpoints, and single step through instructions in the code. This document describes the programming interface for the following Chipcon devices:

| Device Name | Flash memory size(Kbytes) |
|-------------|---------------------------|
| CC1110      | 32 / 16 / 8               |
| CC2430      | 128 / 64 / 32             |
| CC2431      | 128 / 64 / 32             |
| CC2510      | 32 / 16 / 8               |
| CC2511      | 32 / 16 / 8               |

## 2 Hardware interface

The debug interface uses an SPI-like two-wire interface consisting of the bi-directional Debug Data (P2\_1) and Debug Clock (P2\_2) input pin. Data is driven on the bi-directional Debug Data pin at the positive edge of Debug Clock and data is sampled on the negative edge of this clock.

Debug commands are sent by an external host and consist of 1 to 4 output bytes from the host and an optional input byte read by the host. Figure 1 shows a timing diagram of data on the debug interface.

The first byte of the debug command is a command byte and is encoded as follows:

- bits 7 to 3 : instruction code
- bit 2 : return input byte to host
- bits 1 to 0 : number of output bytes from host following instruction code byte



Figure 1: Debug interface timing diagram



#### 2.1 Debug Interface AC Characteristics

| Parameter                             |                   | Min   | Тур | Max | Unit | Condition/Note                    |
|---------------------------------------|-------------------|-------|-----|-----|------|-----------------------------------|
| Debug                                 | CC2430,<br>CC2431 | 31.25 |     |     |      |                                   |
| clock<br>period:                      | CC1110,<br>CC2510 | 38.46 |     |     | ns   | See item 1 Figure 2               |
|                                       | CC2511            | 41.67 |     |     |      |                                   |
| Debug data setup                      |                   | 5     |     |     | ns   | See item 2 Figure 2               |
| Debug data hold                       |                   | 5     |     |     | ns   | See item 3 Figure 2               |
| Clock to data delay                   |                   |       |     | 10  | ns   | See item 4 Figure 2, load = 10 pF |
| RESET_N inactive<br>after P2_2 rising |                   | 10    |     |     | ns   | See item 5 Figure 2               |

 $T_A$ = -40°C to 85°C, VDD=3.0V if nothing else stated.

**Table 1: Debug Interface AC Characteristics** 



#### Figure 2: Debug Interface AC Characteristics

#### 2.2 Debug Lock Bit

For software code security the Debug Interface may be locked. When the Debug Lock bit, DBGLOCK, is set all debug commands except CHIP\_ERASE, READ\_STATUS and GET\_CHIP\_ID are disabled and will not function.

The CHIP\_ERASE command is used to clear the Debug Lock bit.





#### 2.3 Debug Init

Debug mode is entered by forcing two rising edge transitions on pin P2\_2 (Debug Clock) while the RESET\_N input is held low.

#### DEBUG\_INIT()

Resets the chip for debug mode.

| Debug Clock |  |
|-------------|--|
| ResetN      |  |

#### 2.4 Debug Commands

The debug commands are shown in Table 2. Some of the debug commands are described in further detail in the following sections.

| Command       | Instruction code | Description  |
|---------------|------------------|--|
| CHIP_ERASE    | 0001 0x00        | Perform flash chip erase (mass erase) and clear lock bits. If any other command, except READ_STATUS, is issued, then the use of CHIP_ERASE is disabled.  |
| WR_CONFIG     | 0001 1x01        | Write configuration data.  |
| RD_CONFIG     | 0010 0100        | Read configuration data. Returns value set by WR_CONFIG command.   |
| GET_PC        | 0010 1000        | Return value of 16-bit program counter. Returns 2 bytes regardless of value of bit 2 in instruction code   |
| READ_STATUS   | 0011 0x00        | Read status byte.  |
| SET_HW_BRKPNT | 0011 1x11        | Set hardware breakpoint  |
| HALT          | 0100 0100        | Halt CPU operation   |
| RESUME        | 0100 1100        | Resume CPU operation. The CPU must be in halted state for this command to be run.  |
| DEBUG_INSTR   | 0101 01xx        | Run debug instruction. The supplied instruction will be executed by the CPU without incrementing the program counter. The CPU must be in halted state for this command to be run.  |
| STEP_INSTR    | 0101 1100        | Step CPU instruction. The CPU will execute the next instruction from<br>program memory and increment the program counter after execution.<br>The CPU must be in halted state for this command to be run.   |
| STEP_REPLACE  | 0110 01xx        | Step and replace CPU instruction. The supplied instruction will be executed by the CPU instead of the next instruction in program memory. The program counter will be incremented after execution. The CPU must be in halted state for this command to be run. |
| GET_CHIP_ID   | 0110 1000        | Return value of 16-bit chip ID and version number. Returns 2 bytes regardless of value of bit 2 of instruction code  |

Table 2: Debug Commands





#### 2.4.1 CHIP\_ERASE()

Erases the entire flash memory, including lock bits.

Debug command header = 0x14.

| Debug Clock    |  |         |  |
|----------------|--|---------|--|
| Debug Data     |  | discard |  |
| Data Direction |  |         |  |

#### 2.4.2 WR\_CONFIG(IN: config\_8)

Writes the debug configuration byte, which contains the following bits:

- 0x08 TIMERS\_OFF
- 0x04 DMA\_PAUSE
- 0x02 TIMER\_SUSPEND
- 0x01 SEL\_FLASH\_INFO\_PAGE

Debug command header = 0x1D.

| Debug Clock    |        |         |  |
|----------------|--------|---------|--|
| Debug Data     | config | discard |  |
| Data Direction |        |         |  |

#### 2.4.3 READ\_STATUS(OUT: status\_8)

Reads the debug status byte, which contains the following bits:

- 0x80 CHIP\_ERASE\_DONE
- 0x40 PCON\_IDLE
- 0x20 CPU\_HALTED
- 0x10 POWER\_MODE\_0
- 0x08 HALT\_STATUS
- 0x04 DEBUG\_LOCKED
- 0x02 OSCILLATOR\_STABLE
- 0x01 STACK\_OVERFLOW

Debug command header = 0x34.

| Debug Clock    |  |        |   |
|----------------|--|--------|---|
| Debug Data     |  | status | ] |
| Data Direction |  |        |   |

The READ\_STATUS command is used e.g. for polling the status of flash chip erase after a CHIP\_ERASE command or oscillator stable status required for debug commands HALT, RESUME, DEBUG\_INSTR, STEP\_REPLACE and STEP\_INSTR.





#### 2.4.4 GET\_CHIP\_ID(OUT: chip\_id\_8, chip\_rev\_8)

Writes the debug configuration byte, where bit 0 selects the flash information page (containing the lock bits).

Debug command header = 0x68.

| Debug Clock    |         |           |
|----------------|---------|-----------|
| Debug Data     | chip id | chip rev. |
| Data Direction |         |           |

The GET\_CHIP\_ID command returns the Chip\_ID and version number. Chip ID and version number is also accessible for the MCU in the XDATA address range. Table 5 list Chip ID for the Chipcon devices. Version number normally corresponds to the letter describing the revision of the device: 0x01 = A, 0x02 = B, 0x03 = C.

There is one common Chip ID for all memory configurations.

| Bit | Name        | Reset | R/W | Description                                    |
|-----|-------------|-------|-----|--|
| 7:0 | CHIPID[7:0] | 0xXX  | R   | Chip identification number, see table for chip |

#### **Table 3: Register CHIPID**

| Bit | Name         | Reset | R/W | Description          |
|-----|--------------|-------|-----|----------------------|
| 7:0 | VERSION[7:0] | 0xXX  | R   | Chip revision number |

#### **Table 4: Register CHVER**

| Device Name | Chip ID |
|-------------|---------|
| CC1110      | 0x01    |
| CC2430      | 0x85    |
| CC2431      | 0x89    |
| CC2510      | 0x81    |
| CC2511      | 0x91    |

#### Table 5: Chip ID for Chipcon devices

## 2.4.5 HALT()

Halts the CPU

Debug command header = 0x44.







#### 2.4.6 RESUME()

Starts/resumes the CPU

Debug command header = 0x4C.

| Debug Clock    |   |         | 1 |
|----------------|---|---------|---|
| Debug Data     |   | discard | ] |
| Data Direction | Γ |         | ] |

#### 2.4.7 DEBUG\_INSTR(IN: in0\_8, OUT: out0\_8);

Executes a 1-byte 8051 instruction on the CPU, without changing the program counter (unless the debug instruction is a jump operation).

Debug command header = 0x55.

| Debug Clock    |     |      |  |
|----------------|-----|------|--|
| Debug Data     | in0 | out0 |  |
| Data Direction |     |      |  |

#### 2.4.8 DEBUG\_INSTR(IN: in0\_8, in1\_8, OUT: out0\_8);

Executes a 2-byte 8051 instruction on the CPU, without changing the program counter (unless the debug instruction is a jump operation).

Debug command header = 0x56.

| Debug Clock    |     |     |      |
|----------------|-----|-----|------|
| Debug Data     | in0 | in1 | out0 |
| Data Direction |     |     |      |

#### 2.4.9 DEBUG\_INSTR(IN: in0\_8, in1\_8, in2\_8, OUT: out0\_8);

Executes a 3-byte 8051 instruction on the CPU, without changing the program counter (unless the debug instruction is a jump operation).

Debug command header = 0x57.

| Debug Clock    |     |     |     |      |
|----------------|-----|-----|-----|------|
| Debug Data     | in0 | in1 | in2 | out0 |
| Data Direction |     |     | Γ   |      |



## 3 Flash Programming

Programming of the on-chip flash is performed via the debug interface. The external host must initially send instructions using the DEBUG\_INSTR debug command to perform the flash programming with the Flash Controller as described below. The sequences are based on the commands listed in chapter 2.4. For complete description of the flash controller, please see the flash controller section of each datasheet.

#define LOBYTE(w) ((BYTE)(w))
#define HIBYTE(w) ((BYTE)(((WORD)(w) >> 8) & 0xFF))

#### 3.1.1 READ\_CODE\_MEMORY(IN: address\_16, bank\_8, count\_16, OUT: outputArray\_8)

Reads from the specified bank in CODE memory into outputArray, byte by byte.

address < 0x8000: Linear address = address address >= 0x8000: Linear address = (address & 0x7FFF) + (bank \* 0x8000) DEBUG\_INSTR(IN: 0x75, 0xC7, (bank \* 16) + 1, OUT: Discard); DEBUG\_INSTR(IN: 0x90, HIBYTE(address), LOBYTE(address), OUT: Discard); for (n = 0; n < count\_16; n++) { DEBUG\_INSTR(IN: 0xE4, OUT: Discard); DEBUG\_INSTR(IN: 0x93, OUT: outputArray[n]); DEBUG\_INSTR(IN: 0xA3, OUT: Discard); } MOV MEMCTR, (bank \* 16) + 1; MOV DPTR, address; CLR A; MOVC A, @A+DPTR; (outputArray[n] = A) INC DPTR; }

#### 3.1.2 READ\_XDATA\_MEMORY(IN: address\_16, count\_16, OUT: outputArray\_8)

Reads from XDATA memory into inputArray, byte by byte.

```
DEBUG_INSTR(IN: 0x90, HIBYTE(address), LOBYTE(address), OUT: Discard); MOV DPTR, address;
for (n = 0; n < count; n++) {
    DEBUG_INSTR(IN: 0xE0, OUT: outputArray[n]); MOVX A, @DPTR; (outputArray[n] = A)
    DEBUG_INSTR(IN: 0xA3, OUT: Discard); INC DPTR;
}
```



#### 3.1.3 WRITE\_XDATA\_MEMORY(IN: address\_16, count\_16, inputArray\_8)

Writes data from inputArray into XDATA memory, byte by byte.

```
DEBUG_INSTR(IN: 0x90, HIBYTE(address), LOBYTE(address), OUT: Discard);
for (n = 0; n < count; n++) {
DEBUG_INSTR(IN: 0x74, inputArray[n], OUT: Discard);
DEBUG_INSTR(IN: 0xF0, OUT: Discard);
DEBUG_INSTR(IN: 0xA3, OUT: Discard);
}
MOV A, #inputArray[n];
MOVX @DPTR, A;
INC DPTR;
}</pre>
```

## 3.1.4 SET\_PC(IN: address\_16)

Modifies the program counter value

DEBUG\_INSTR(IN: 0x02, HIBYTE(address), LOBYTE(address), OUT: Discard); LJMP address;

#### 3.1.5 CLOCK\_INIT()

Initializes the 32 MHz crystal oscillator

#### Important:

• The loop can lock up if the operation fails (due to communication or chip errors). If polling is not desirable, then wait for 1 ms instead.

| <pre>DEBUG_INSTR(IN: 0x75, 0xC6, 0x00);</pre>          | MOV CLKCON, #00H;              |
|--|--------------------------------|
| do {   |                                |
| <pre>DEBUG_INSTR(IN: 0xE5, 0xBE, OUT: sleepReg);</pre> | MOV A, SLEEP; $(sleepReg = A)$ |
| <pre>} while (!(sleepReg &amp; 0x40));</pre>           |                                |



#### 3.1.6 WRITE\_FLASH\_PAGE(IN: address\_17, inputArray\_8, erase\_page\_1)

Writes a single flash page by loading the image into XDATA memory, together with an assembly routine that performs the actual update. This is done by using unified mapping.

The marked section, which performs page erasure, should only be included in the routine when the erase\_page\_1 = 1. The pseudo-code does not refer to this parameter!

| routine_8[] = {  |                              |                                    |
|--|------------------------------|------------------------------------|
| 0x75, 0xAD, ((address >> 8) / FLASH_WORD_SIZE) & 0x7E, | //                           | MOV FADDRH, #imm;                  |
| 0x75, 0xAC, 0x00,                                      | //                           | MOV FADDRL, #00;                   |
| 0x75, 0xAE, 0x01,                                      | 11                           | MOV FLC, #01H; // ERASE            |
|  | 11                           | ; Wait for flash erase to complete |
| 0xE5, 0xAE,  | <pre>// eraseWaitLoop:</pre> | MOV A, FLC;                        |
| 0x20, 0xE7, 0xFB,                                      | 11                           | JB ACC_BUSY, eraseWaitLoop;        |
|  | //                           | ; Initialize the data pointer      |
| 0x90, 0xF0, 0x00,                                      | //                           | MOV DPTR, #0F000H;                 |
|  | //                           | ; Outer loops                      |
| <pre>0x7F, HIBYTE(WORDS_PER_FLASH_PAGE),</pre>         | //                           | MOV R7, #imm;                      |
| <pre>0x7E, LOBYTE(WORDS_PER_FLASH_PAGE),</pre>         | //                           | MOV R6, #imm;                      |
| 0x75, 0xAE, 0x02,                                      | //                           | MOV FLC, #02H; // WRITE            |
|  | //                           | ; Inner loops                      |
| 0x7D, FLASH_WORD_SIZE,                                 | // writeLoop:                | MOV R5, #imm;                      |
| Oxeo,  | // writeWordLoop:            | MOVX A, @DPTR;                     |
| 0xA3,  | //                           | INC DPTR;                          |
| 0xF5, 0xAF,  | //                           | MOV FWDATA, A;                     |
| 0xDD, 0xFA,  | //                           | DJNZ R5, writeWordLoop;            |
|  | //                           | ; Wait for completion              |
| Oxe5, Oxae,  | // writeWaitLoop:            | MOV A, FLC;                        |
| 0x20, 0xE6, 0xFB,                                      | //                           | JB ACC_SWBSY, writeWaitLoop;       |
| OxDE, OxF1,  | //                           | DJNZ R6, writeLoop;                |
| 0xDF, 0xEF,  | //                           | DJNZ R7, writeLoop;                |
|  | //                           | ; Done, fake a breakpoint          |
| 0xA5   | //                           | DB 0xA5;                           |

<sup>};</sup> 



WRITE\_XDATA\_MEMORY(IN: 0xF000, FLASH\_PAGE\_SIZE, inputArray\_8); WRITE\_XDATA\_MEMORY(IN: 0xF000 + FLASH\_PAGE\_SIZE, sizeof(routine), routine); DEBUG\_INSTR(IN: 0x75, 0xC7, 0x51, OUT: Discard); MOV MEMCTR, (bank \* 16) + 1; SET\_PC(0xF000 + FLASH\_PAGE\_SIZE); RESUME(); do { READ\_STATUS(OUT: statusByte); } while (!(statusByte & CPU\_HALTED));

#### 3.1.7 READ\_FLASH\_PAGE(IN: linearAddress\_17, OUT: outputArray\_8)

Reads one page from flash memory

READ\_CODE\_MEMORY(address & 0xFFFF, (linearAddress >> 15) & 0x03, FLASH\_PAGE\_SIZE, outputArray);



#### 3.1.8 MASS\_ERASE\_FLASH()

Initiates a mass erase, which blanks out the entire flash memory and lock bits, and then waits for the operation to complete. The initial NOP ensures that the status byte has been updated

Important:

• The loop can lock up if the operation fails (due to communication or chip errors). If polling is not desirable, then wait for 20 ms instead.

```
DEBUG_INSTR(IN: 0x00, OUT: Discard);
CHIP_ERASE();
do {
    READ_STATUS(OUT: statusByte);
} while (!(statusByte & CHIP_ERASE_DONE));
```

NOP;

## 3.1.9 PROGRAM\_FLASH(IN: imageArray\_8, OUT: verificationIsOk\_1)

Programs the entire flash memory and verifies it.

The logic in this pseudo-code requires that the size of the image array matches the total size of the flash memory in the device to be programmed (e.g. 128 kB for the CC2430F128). It also requires unused addresses to be set to 0xFF.

```
DEBUG_INIT();
CLOCK_INIT();
MASS_ERASE_FLASH();
verificationArray_8[FLASH_PAGE_SIZE];
verificationIsOk = 1;
for (p = 0; p < (FLASH_SIZE / FLASH_PAGE_SIZE); p++) {
    pageAddress = p * FLASH_PAGE_SIZE;
    memset(verificationArray, 0xFF, FLASH_PAGE_SIZE);
    if (memcmp(verificationArray, &inputArray[pageAddress], FLASH_PAGE_SIZE)) {
        WRITE_FLASH_PAGE(IN: pageAddress, &inputArray[pageAddress], 0);
        READ_FLASH_PAGE(IN: pageAddress, verificationArray);
        if (memcmp(verificationArray, &inputArray[pageAddress], FLASH_PAGE_SIZE)) {
            verificationIsOk = 0;
            return;
        }
    }
}
```

## 3.1.10 Flash Write Timing

The Flash Controller contains a timing generator, which controls the timing sequence of flash write and erase operations. The timing generator uses the information set in the Flash Write Timing register, FWT.FWT[5:0], to set the internal timing. FWT.FWT[5:0] must be set to a value according to the currently selected CPU clock frequency.

The value set in the FWT.FWT[5:0] shall be set according to the CPU clock frequency by the following equation.

 $FWT = \frac{21000 * F_{CPU}}{16 * 10^9}$ 

 $F_{CPU}$  is the CPU clock frequency. The initial value held in FWT.FWT[5:0] after a reset is 0x2A which corresponds to 32 MHz CPU clock frequency.

The FWT values for common CPU clock frequencies are given in Table 6.

| CPU clock<br>frequency (MHz) | FWT  |
|------------------------------|------|
| 12                           | 0x10 |
| 13                           | 0x11 |
| 16                           | 0x15 |
| 24                           | 0x20 |
| 26                           | 0x23 |
| 32                           | 0x2A |

Table 6: Flash timing (FWT) values





## 4 Document history

| Version | Data       | Description/Changes  |
|---------|------------|--|
| 1.2     | 22-12-2006 | Removed classification "Chipcon internal and partners with NDA", |
|         |            | added CC1110, CC2510, CC2511 data.                               |
| 1.1     | 27-04-2006 | Bug fix in WRITE_FLASHPAGE, changed value in HALT and            |
|         |            | RESUME, deleted chapter READ_FLASH_PAGE (was written twice).     |
| 1.0     |            | Initial  |



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